

STN	Integrácia softvérového nástroja (FDI®) Časť 6-100: Technologické mapovanie - .Net	STN EN IEC 62769-6-100 18 4012
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Field Device Integration (FDI) - Part 6-100: Technology Mapping - .Net

Táto norma obsahuje anglickú verziu európskej normy.
This standard includes the English version of the European Standard.

Táto norma bola oznámená vo Vestníku ÚNMS SR č. 07/23

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English Version

**Field Device Integration (FDI®) - Part 6-100: Technology
Mapping - .Net
(IEC 62769-6-100:2023)**

Intégration des appareils de terrain (FDI®) - Partie 6-100:
Mapping de technologies - .Net
(IEC 62769-6-100:2023)

Feldgeräteintegration (FDI®) - Teil 6-100: FDI-
Technologieabbildungen - .Net
(IEC 62769-6-100:2023)

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EN IEC 62769-6-100:2023 (E)**European foreword**

The text of document 65E/868/CDV, future edition 1 of IEC 62769-6-100, prepared by SC 65E "Devices and integration in enterprise systems" of IEC/TC 65 "Industrial-process measurement, control and automation" was submitted to the IEC-CENELEC parallel vote and approved by CENELEC as EN IEC 62769-6-100:2023.

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IEC 61804 (series) NOTE Approved as EN IEC 61804 (series)

Annex ZA (normative)

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<u>Publication</u>	<u>Year</u>	<u>Title</u>	<u>EN/HD</u>	<u>Year</u>
IEC 62769-1	2021	Field Device Integration (FDI) - Part 1: Overview	EN IEC 62769-1	2021
IEC 62769-2	-	Field Device Integration (FDI®) - Part 2: Client	EN IEC 62769-2	-
IEC 62769-4	-	Field Device Integration (FDI®) - Part 4: FDI Packages	EN IEC 62769-4	-
IEC 62769-6	-	Field Device Integration (FDI®) - Part 6: FDI Technology Mappings	EN IEC 62769-6	-



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INTERNATIONAL STANDARD

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**Field Device Integration (FDI®) –
Part 6-100: Technology Mapping – .Net**

**Intégration des appareils de terrain (FDI®) –
Partie 6-100: Mapping de technologies – .Net**



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INTERNATIONAL STANDARD

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**Field Device Integration (FDI®) –
Part 6-100: Technology Mapping – .Net**

**Intégration des appareils de terrain (FDI®) –
Partie 6-100: Mapping de technologies – .Net**

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FIELD DEVICE INTEGRATION (FDI®) –**Part 6-100: Technology Mapping – .NET**

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The text of this International Standard is based on the following documents:

Draft	Report on voting
65E/868/CDV	65E/925/RVC

Full information on the voting for its approval can be found in the report on voting indicated in the above table.

The language used for the development of this International Standard is English.

This document was drafted in accordance with ISO/IEC Directives, Part 2, and developed in accordance with ISO/IEC Directives, Part 1 and ISO/IEC Directives, IEC Supplement, available at www.iec.ch/members_experts/refdocs. The main document types developed by IEC are described in greater detail at www.iec.ch/publications.

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FIELD DEVICE INTEGRATION (FDI®) – Part 6-100: Technology Mapping – .NET

1 Scope

This part of IEC 62769 specifies the technology mapping for the concepts described in the Field Device Integration (FDI®¹) standard. The technology mapping focuses on implementation regarding the components FDI® Client and User Interface Plug-in (UIP) using the Runtime .NET. This runtime is specific only to the WORKSTATION platform as defined in IEC 62769-4.

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